

## CDR31BX103AMZP-T&R

Aliases (C0805N103M5XPL7189)

SMD Mil PRF55681, Ceramic, 0.01 uF, 20%, 50 VDC, BX, P (0.1%/1000 Hrs), 0805



Click here for the 3D model.

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm (0.079 in +/-0.008 in)
W	1.25mm +/-0.2mm (0.049 in +/-0.008 in)
Т	1.3mm (0.051 in)
В	0.5mm +/-0.2mm (0.02 in +/-0.008 in)

Packaging Specifications		
Packaging	T&R, 178mm, Plastic Tape	
Packaging Quantity	2500	

General Information	
Series	SMD Mil PRF55681
Style	SMD Chip
RoHS	No
Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
SCIP Number	db44bada-287e-465e-9a06-2b93bb6487ea
Termination	Lead (SnPb)
Failure Rate	P (0.1%/1000 Hrs)
Testing and Reliability	MIL-PRF-55681
Qualifications	MIL-PRF-55681
AEC-Q200	No
Miscellaneous	Termination Description: SolderPlate 70-30.
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.01 uF
Capacitance Tolerance	20%
Voltage DC	50 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BX

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